



14 May 2008

Statement Regarding the use of PFOS in Spansion Flash Memory Products

EU Directive 2006/122/EC restricts PFOS (Perfluorooctanesulfonates) in goods put on the EU market as of June 27, 2008.

Spansion has evaluated the use of PFOS and PFOA (Perfluorooctanoic acid) and concluded these compounds play important roles in the photo resists and anti-reflective coatings used in the semiconductor industry for manufacture of integrated circuit die. Regulatory exemptions will allow us to continue using these materials in critical applications until technically viable alternatives are available.

Spansion recognizes the potential environmental and human health impacts associated with this category of chemicals, and is actively working with our suppliers to identify PFOS- and PFOA-free alternatives. In the interim, Spansion is actively minimizing the use of these materials in its worldwide operations, and is working with trade associations to eliminate or reduce their impact to the environment.

While our IC manufacturing process uses PFOS, neither PFOS nor PFOA are contained in Spansion's final products.

A complete listing of items present in Spansion products is listed in Material Data Declaration Sheets posted online at:
www.spansion.com/datasheets/spansion-03packagematerials.pdf

Regards,

Spansion, Inc.

A handwritten signature in black ink that reads "Gene Daszko". The signature is written in a cursive style and is set against a light green rectangular background.

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